

AN-1572 Quick Start Guide for a 3 Amp Buck Regulator Using the LM5576 and LM25576

ABSTRACT

This application note provides an easy to use process to design a 3 Amp buck regulator using the LM5576 and LM25576 switching regulators.

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Introduction www.ti.com

1 Introduction

The LM5576 and LM25576 switching regulators feature all of the functions necessary to implement an efficient high voltage buck regulator using a minimum of external components. These easy to use regulators include either a 42V (LM25576) or a 75V (LM5576) N-Channel buck switch with an output current capability of 3 Amps. The operating frequency is programmable from 50kHz up to 1MHz. Protection features include: current limit, thermal shutdown and remote shutdown capability. The device is available in a power enhanced TSSOP-20 package featuring an exposed die attach pad to aid thermal dissipation.

This step-by-step guide provides an easy to use process to quickly select the external components necessary to complete a design. More detailed information including theory of operation, design trade-offs and additional application guidance is available in the device datasheet. Shown below in Figure 1 is a complete schematic for a 3 Amp step-down DC-DC converter. Several external component values can be standardized for most applications. The input voltage range, output voltage and desired operating frequency dictate the remaining component values.

An Excel based spreadsheet derived from the guide is available on www.ti.com.

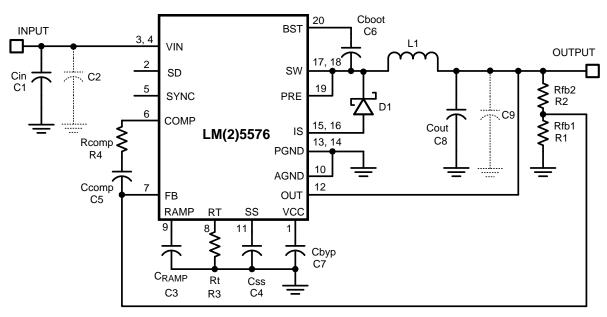


Figure 1. Application Schematic



2	Quick	Guide	Design	Worksheet
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Step 1. List the basic requirements:

Output Current: 0 to 3 Amp

Output Voltage:	 V [1]
Input Voltage Min Spec:	 V [2]
Input Voltage Max Spec:	 V [3]

Step 2. If the Input Voltage Max Spec [3] is less than 42V use the LM25576. If the Input Voltage Max Spec [3] is greater than 42V but less than 75V use the LM5576. Both devices require the Input Voltage Min Spec [2] to be greater than 6V.

Selected Regulator:	[4
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Step 3. Selection of the operating frequency is a trade-off between the conversion efficiency and solution size. Operating at a high frequency, with a relatively high input voltage will severely impact the efficiency and consequently generate a lot of heat. In some applications, the selection of a high operating frequency will limit the input voltage range. The recommended maximum operating frequency for applications using LM5576 is 500 kHz. When using the LM25576 the operating frequency may be set as high as 1MHz. Select a target operating frequency from 50 kHz to 1MHz (500kHz for the LM5576). Check to see if the Vin(min) limits the selected operating frequency:

Fsw(max) =
$$\frac{Vin(min)[2] - (Vout[1] + 0.6)}{Vin(min)[2] \times 5.5 \times 10^{-7}}$$
 (1)

The selected operating frequency must be less than Fsw(max) calculated above, if not reduce the operating frequency. Check to see if the Vin(max) limits the selected operating frequency:

$$Fsw(max) = \frac{(Vout[1] + 0.6)}{Vin(max)[3] \times 8 \times 10^{-8}}$$
(2)

The selected operating frequency must be less than Fsw(max) calculated above, if not reduce the operating frequency.

Selected operating frequency	Hz [5]
Fsw:	

Step 4. Calculate the value of Rt for the selected operating frequency.

$$Rt = \frac{\frac{1}{Fsw[5]} - 580 \times 10^{-9}}{135 \times 10^{-12}}$$
(3)

Selected value for R1: Ohms [6]

Step 5. Calculate the value of L1.

$$L1 = \frac{\text{Vout[1] x (Vin(max)[3] - Vout[1])}}{0.8 \text{ x Fsw[6] x Vin(max)[3]}}$$
(4)

Select the nearest standard inductor value. During an overload condition the peak inductor current is limited to 4.5A nominal (5.1A maximum). The selected inductor must be rated for peak current of at least 5.1 Amps.

Selected value of L1: Henrys [7]



Guide Design Worksheet	www.ti.com
Step 6. Calculate the value of C_{RAMP} : $C_{RAMP} = L1[7] \times 10^{-5}$	(5)
Selected value of C _{RAMP} :	Farads [8]
Step 7. Set Rfb2 to 5kOhms if Vout[1] is less that Rfb2 to 10K Ohms.	an or equal to 5 Volts. If Vout[1] is greater than 5V set
Selected value of Rfb2:	Ohms [9]
Calculate the value of Rfb1: $Rfb1 = \frac{1.225 \times Rfb2[9]}{(Vout[1] - 1.225)}$	(6)
Selected value of Rfb1:	Ohms [10]
diodes are not recommended and may result in transients. The reverse breakdown rating should some safety margin. For worst case design, ass will carry the output current almost continuously.	chottky type diode is required for all applications. Ultra-fast damage to the IC due to reverse recovery current dibe greater than the Input Voltage Max Spec[3], plus sume a short circuit load condition. In this case the diode . This current can be as high as 5.1A. Assuming a 0.6V er dissipation can be as high as 3W. A DPAK or SMC
Selected diode part number:	[11]
supplying most of the switch current during the cinput capacitor(s) is 1.5Amp. A quality ceramic capacitor voltage rating should be greater than the A guide to select the input capacitor(s) value in	essary to limit the ripple voltage at the VIN pin while con-time. The minimum RMS ripple current rating for the capacitor(s) with a low ESR is recommended. The input the Input Voltage Max Spec [3], plus some safety margin. proportion to the operating frequency is:
$Cin = \frac{1.5}{Fsw[5]}$	(7)
Selected value for Cin: Farads:	[12]
transient loading conditions. A good starting point capacitor (10 μ F to 47 μ F) and a low ESR organicapacitor provides ultra low ESR to reduce the capacitor provides a source of charge for transic should be greater than the Output Voltage Specioutput ripple voltage is:	luctor ripple current and provide a source of charge for nt for the output capacitance is to parallel a ceramic nic or tantalum capacitor (22 µF to 220 µF). The ceramic output ripple voltage and noise spikes, while the larger bulk ent loading conditions. The output capacitor voltage rating [1], plus some safety margin. An approximation for the
$\Delta Vout = 0.8 x \left(ESR + \frac{1}{8 x Fsw[5] x Cout} \right)$	(8)

Selected value for Cout:

Farads [13]



Step 11. Ccomp and Rcomp configure the error amplifier gain characteristics to accomplish a stable overall loop gain. One advantage of current mode control is the ability to close the loop with only two feedback components. Calculate the value of Rcomp:

Step 12. Shown in Table 1 is the Bill of Materials for your design. Transcribe each value [#] from worksheet above into the following table. Congratulations, you're done.

2.1 Bill of Materials

Table 1. Bill of Materials

SCH REF	PART NUMBER	DESCRIPTION	VALUE	WORK SHEET REF
C1 (Cin)		INPUT CAPACITOR		[12]
C2 (Cin)		OPTIONAL INPUT CAPACITOR		[12]
C3 (C _{RAMP})		RAMP CAPACITOR		[8]
C4 (Css)	C2012X7R2A103K	CAPACITOR, TDK	0.01µ, 100V	
C5 (Ccomp)		COMPENSATION CAP		[15]
C6 (Cboot)	C2012X7R2A223K	CAPACITOR, TDK	0.047µ, 100V	
C7 (Cbyp)	C2012X7R1C474M	CAPACITOR, TDK	0.47µ, 16V	
C8 (Cout)		OUTPUT CAPACITOR		[13]
C9 (Cout)		OPTIONAL OUTPUT CAPACITOR		[13]
D1		SCHOTTKY DIODE		[11]
L1		INDUCTOR		[7]
R1 (Rfb1)		Feedback RESISTOR		[10]
R2 (Rfb2)		Feedback RESISTOR		[9]
R3 (Rt)		TIMING RESISTOR		[6]
R4 (Rcomp)		COMPENSATION RESISTOR		[14]
U1		REGULATOR, TI		[4]

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